



Parameter	Rating	Units
Load Voltage	250	V
Load Current	50	mA
Max $R_{ON}$	100	$\Omega$

### Features

- Small 8 Pin DIP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 3750V<sub>rms</sub> Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Surface Mount and Tape & Reel Versions Available

### Applications

- Telecommunications
  - Telecom Switching
  - Tip/Ring Circuits
  - Modem Switching (Laptop, Notebook, Pocket Size)
  - Hook Switch
  - Dial Pulsing
  - Ground Start
  - Ringing Injection
- Instrumentation
  - Multiplexers
  - Data Acquisition
  - Electronic Switching
  - I/O Subsystems
  - Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

### Description

OAA160 is a 250V, 50mA, 100 $\Omega$  dual 1-Form-A relay. This high performance product provides the fastest (0.125ms) switching available for two independent Form-A relays in a single package.

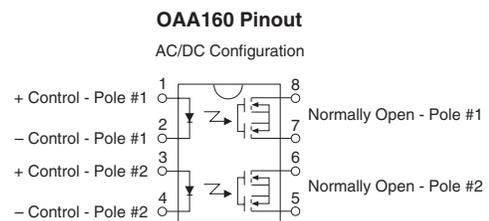
### Approvals

- UL Recognized: File Number E76270
- CSA Certified: File Number LR 43639-10
- Certified to:
  - EN 60950
  - EN 41003

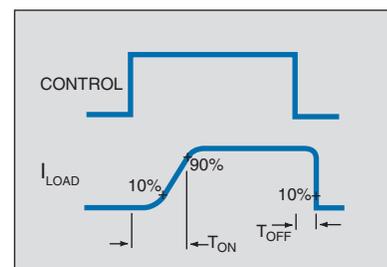
### Ordering Information

Part #	Description
OAA160	8 Pin DIP (50/tube)
OAA160P	8 Pin Flatpack (50/tube)
OAA160PTR	8 Pin Flatpack (1000/Reel)
OAA160S	8 Pin Surface Mount (50/tube)
OAA160STR	8 Pin Surface Mount (1000/Reel)

### Pin Configuration



### Switching Characteristics of Normally Open (Form A) Devices



### Absolute Maximum Ratings (@ 25° C)

Parameter	Ratings	Units
Blocking Voltage	250	V
Reverse Input Voltage	5	V
Input Control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	150 <sup>1</sup>	mW
Total Power Dissipation	800 <sup>2</sup>	mW
Isolation Voltage, Input to Output	3750	V <sub>rms</sub>
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C

<sup>1</sup> Derate Linearly 1.33 mW/°C

<sup>2</sup> Derate Linearly 6.67 mW/°C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

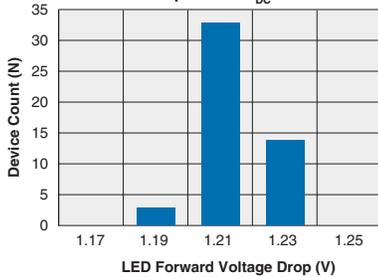
### Electrical Characteristics

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics @ 25°C</b>						
Load Current* AC/DC Configuration	Continuous	I <sub>L</sub>	-	-	50	mA
Peak Load Current	t=10ms	I <sub>LPK</sub>	-	-	100	mA
On-Resistance AC/DC Configuration	I <sub>L</sub> =50mA	R <sub>ON</sub>	-	50	100	Ω
Off-State Leakage Current	V <sub>L</sub> =250V	I <sub>LEAK</sub>	-	-	0.025	μA
<b>Switching Speeds</b>						
Turn-On	I <sub>F</sub> =10mA, V <sub>L</sub> =10V	T <sub>ON</sub>	-	-	0.125	ms
Turn-Off	I <sub>F</sub> =10mA, V <sub>L</sub> =10V	T <sub>OFF</sub>	-	-	0.125	ms
Turn-On	I <sub>F</sub> =4.0mA, V <sub>L</sub> =10V	T <sub>ON</sub>	0.060	-	0.150	ms
Turn-Off	I <sub>F</sub> =4.0mA, V <sub>L</sub> =10V	T <sub>OFF</sub>	-	-	0.055	ms
Output Capacitance	50V; f=1MHz	C <sub>OUT</sub>	-	5	-	pF
<b>Input Characteristics @ 25°C</b>						
Input Control Current	I <sub>L</sub> =50mA	I <sub>F</sub>	-	-	3	mA
Input Dropout Current	-	I <sub>F</sub>	0.4	0.7	-	mA
Input Voltage Drop	I <sub>F</sub> =10mA	V <sub>F</sub>	0.9	1.2	1.4	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA
Input to Output Capacitance	-	C <sub>I/O</sub>	-	3	-	pF

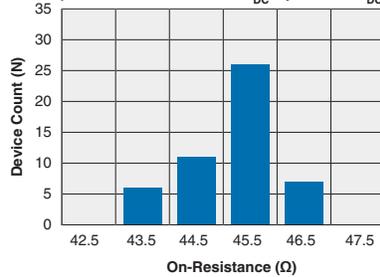
\*NOTE: If both poles operate simultaneously load current must be derated so as not to exceed the package power dissipation value.

**PERFORMANCE DATA\***

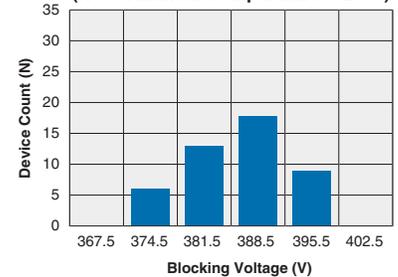
**OAA160**  
Typical LED Forward Voltage Drop  
(N=50 Ambient Temperature = 25°C)  
 $I_F = 10\text{mA}_{DC}$



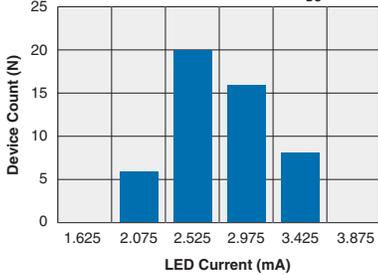
**OAA160**  
Typical On-Resistance Distribution  
(N=50 Ambient Temperature = 25°C)  
(Load Current =  $50\text{mA}_{DC}$ ;  $I_F = 10\text{mA}_{DC}$ )



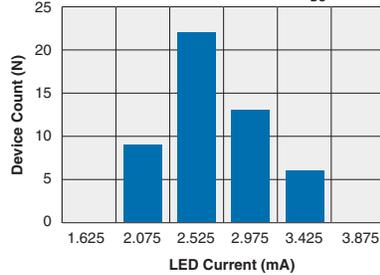
**OAA160**  
Typical Blocking Voltage Distribution  
(N=50 Ambient Temperature = 25°C)



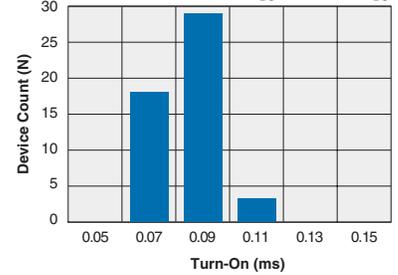
**OAA160**  
Typical  $I_F$  for Switch Operation  
(N=50 Ambient Temperature = 25°C)  
(Load Current =  $50\text{mA}_{DC}$ )



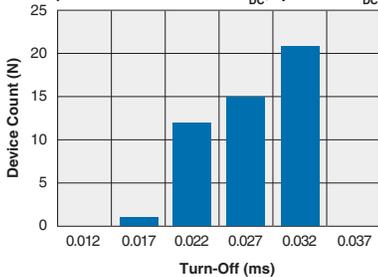
**OAA160**  
Typical  $I_F$  for Switch Dropout  
(N=50 Ambient Temperature = 25°C)  
(Load Current =  $50\text{mA}_{DC}$ )



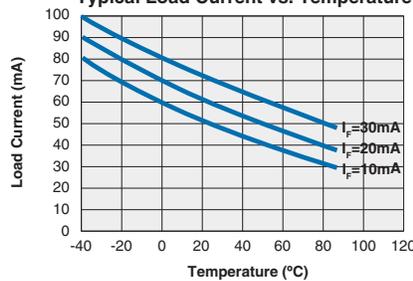
**OAA160**  
Typical Turn-On Time  
(N=50 Ambient Temperature = 25°C)  
(Load Current =  $50\text{mA}_{DC}$ ;  $I_F = 10\text{mA}_{DC}$ )



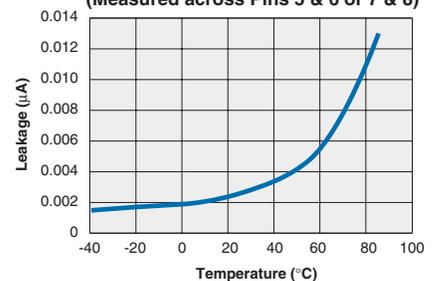
**OAA160**  
Typical Turn-Off Time  
(N=50 Ambient Temperature = 25°C)  
(Load Current =  $50\text{mA}_{DC}$ ;  $I_F = 10\text{mA}_{DC}$ )



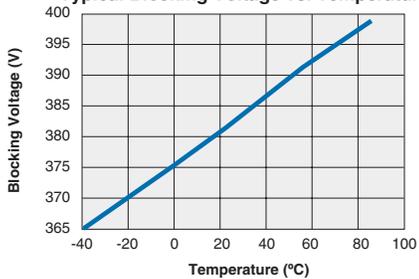
**OAA160**  
Typical Load Current vs. Temperature



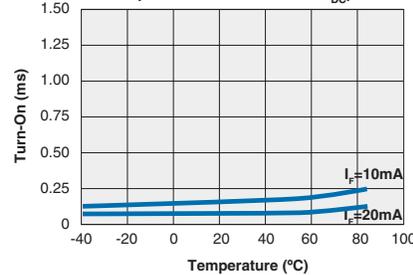
**OAA160**  
Typical Leakage vs. Temperature  
(Measured across Pins 5 & 6 or 7 & 8)



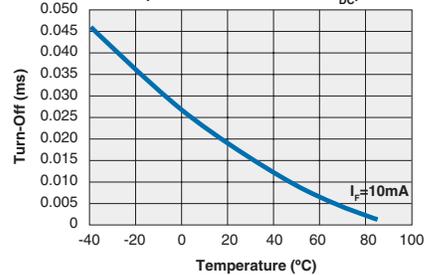
**OAA160**  
Typical Blocking Voltage vs. Temperature



**OAA160**  
Typical Turn-On vs. Temperature  
(Load Current =  $50\text{mA}_{DC}$ )

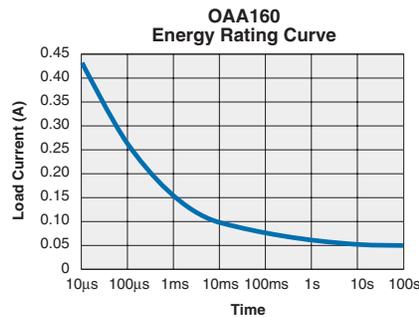
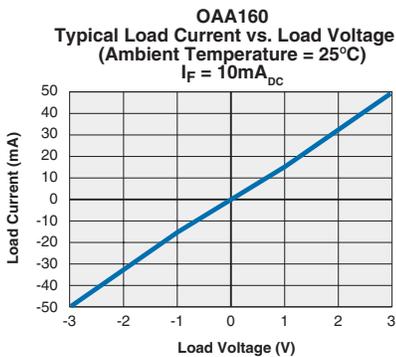
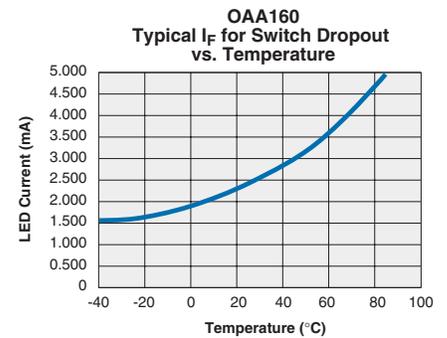
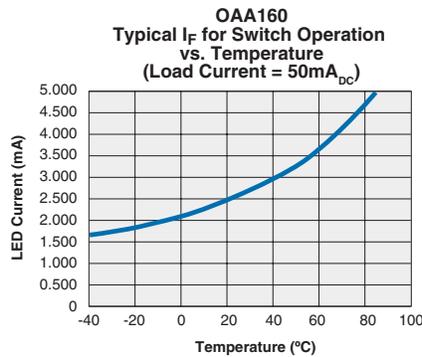
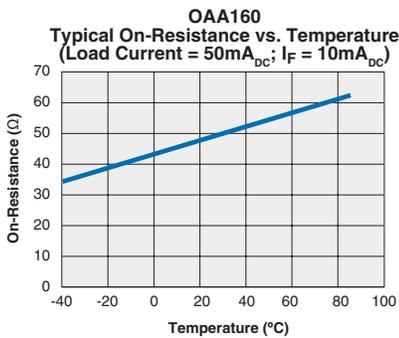
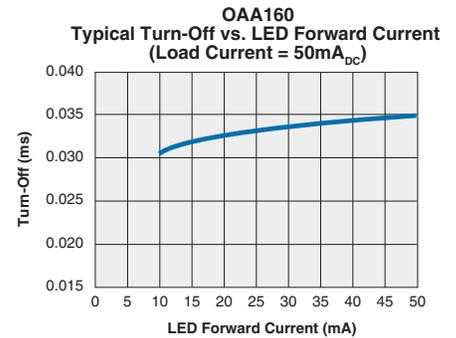
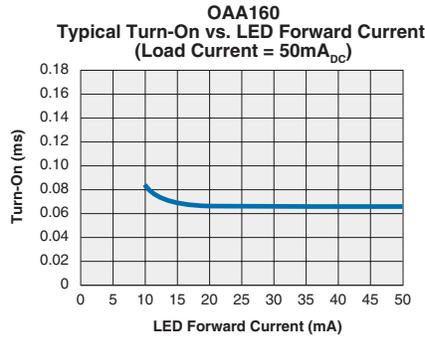
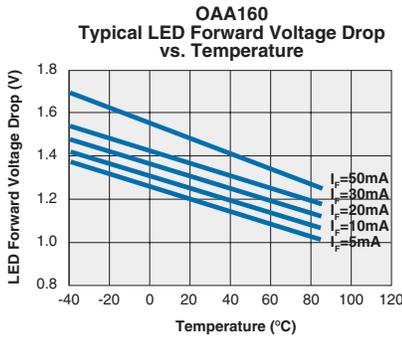


**OAA160**  
Typical Turn-Off vs. Temperature  
(Load Current =  $50\text{mA}_{DC}$ )



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

PERFORMANCE DATA\*



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**Manufacturing Information**

**Soldering**

For proper assembly, the component must be processed in accordance with the current revision of IPC/JEDEC standard J-STD-020. Failure to follow the recommended guidelines may cause permanent damage to the device resulting in impaired performance and/or a reduced lifetime expectancy.

Recommended soldering processes are limited to 260°C component body temperature for 10 seconds.

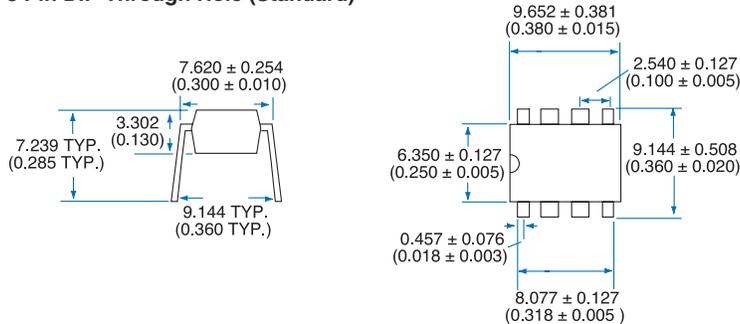
**Washing**

Clare does not recommend ultrasonic cleaning or the use of chlorinated solvents.

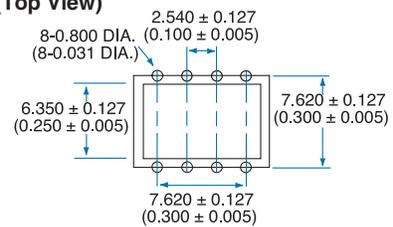


**MECHANICAL DIMENSIONS**

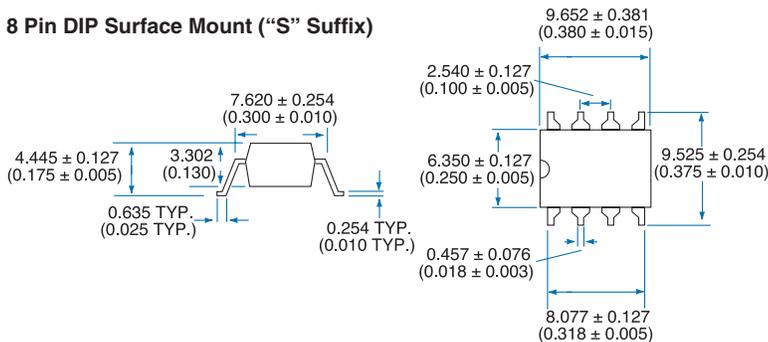
**8 Pin DIP Through Hole (Standard)**



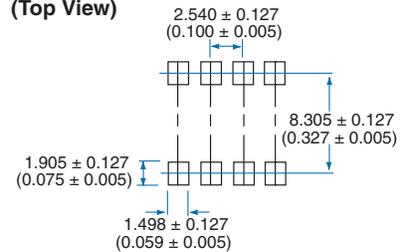
**PC Board Pattern (Top View)**



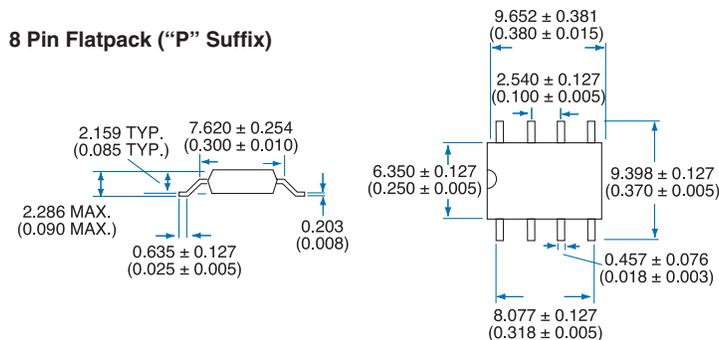
**8 Pin DIP Surface Mount ("S" Suffix)**



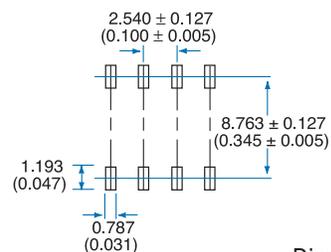
**PC Board Pattern (Top View)**



**8 Pin Flatpack ("P" Suffix)**



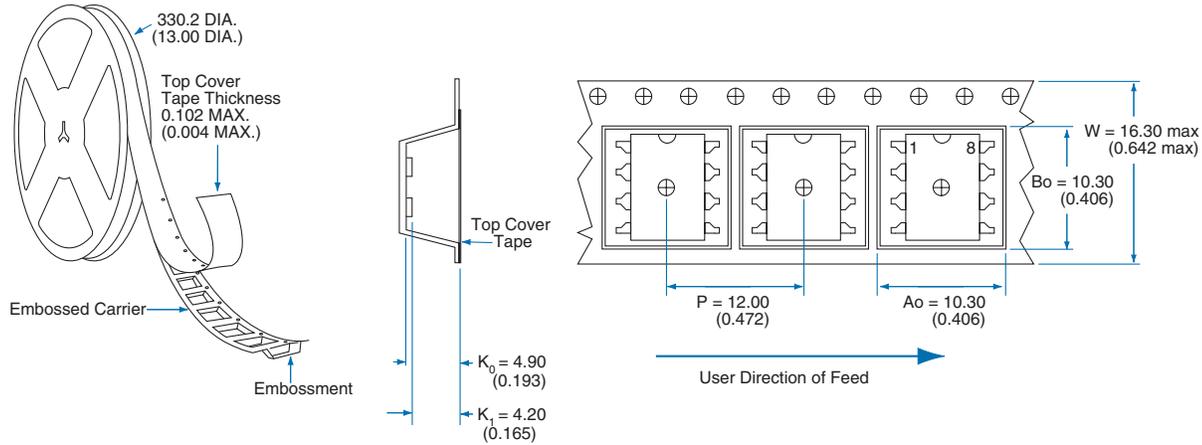
**PC Board Pattern (Top View)**



Dimensions:  
mm  
(inches)

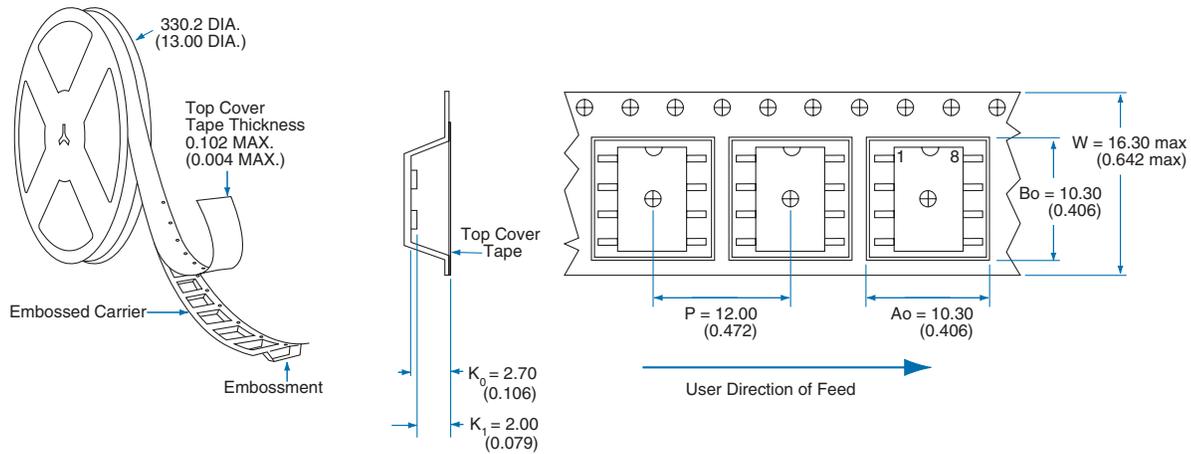
**MECHANICAL DIMENSIONS**

**Tape and Reel Packaging for 8-Pin Surface Mount Package**



**NOTE:** Tape dimensions not shown, comply with JEDEC Standard EIA-481-2

**Tape and Reel Packaging for 8-Pin Flatpack Package**



**NOTE:** Tape dimensions not shown, comply with JEDEC Standard EIA-481-2

**Dimensions:**  
mm  
(inches)

**For additional information please visit our website at: [www.clare.com](http://www.clare.com)**

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